



## Low-Power Single/Dual-Supply Dual Comparator with Reference

## FEATURES

- Ultra-Low Quiescent Current: 4µA (max), Both Comparators plus Reference
- ♦ Single or Dual Power Supplies: Single: +2.5V to +11V Dual: ±1.25V to ±5.5V
- Input Voltage Range Includes Negative Supply
- ♦ 7µs Propagation Delay
- Push-pull TTL/CMOS-Compatible Outputs
- ♦ Crowbar-Current-Free Switching
- Continuous Source Current Capability: 40mA
- ♦ Internal 1.182V ±0.75% Reference
- Adjustable Hysteresis
- ♦ 8-pin MSOP Package

## **APPLICATIONS**

Threshold Detectors Window Comparator Level Translators Oscillator Circuits Battery-Powered Systems

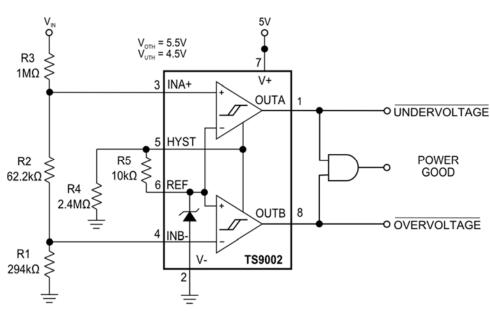
## DESCRIPTION

The TS9002 low-voltage, micropower dual analog comparator is form-factor identical to the MAX923 analog comparator with improved electrical specifications. Ideal for 3V or 5V single-supply applications, the TS9002 draws 11% lower supply current with a 25%-better initial accuracy reference voltage. The TS9002 joins the TS9001-1/2 analog comparators in the "NanoWatt Analog<sup>TM</sup>" high performance analog integrated circuits portfolio. The TS9002 can operate from single +2.5V to +11V supplies or from  $\pm 1.25$ V to  $\pm 5.5$ V dual supplies.

The TS9002 exhibits an input voltage range from the negative supply rail to within 1.3V of the positive supply rail. In addition, its push-pull output stage is TTL/CMOS compatible and capable of sinking and sourcing current. It also incorporates an internal 1.182V  $\pm 0.75\%$  voltage reference. Without complicated feedback configurations and only requiring two additional resistors, adding external hysteresis via a separate pin is available on the TS9002's HYST pin.

The TS9002 is fully specified over the  $-40^{\circ}$ C to  $+85^{\circ}$ C temperature range and is available in an 8-pin MSOP package.

# TYPICAL APPLICATION CIRCUIT



### A 5V, Low-Parts-Count, High-Accuracy Window Detector

**Output Current** 



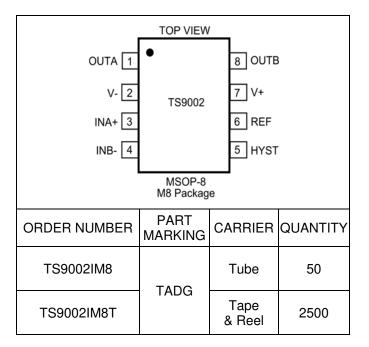
## **ABSOLUTE MAXIMUM RATINGS**

	_	
Supply Voltage (V+ to V	/-, V+ to GND, GND to V-)0	.3V, +12V
Voltage Inputs		
	(V+ + 0.3V) to (	
HYST	(REF + 5V) to (	V0.3V)
Output Voltage		
REF	(V+ + 0.3V) to (	V 0.3V)
OUT	(V+ + 0.3V) to (	V0.3V)
Input Current (IN+, IN-,	HYST)	20m⁄A
OUT Input Current (IN+, IN-,	(V+ + 0.3V) to ( HYST)	V 0.3V) 20mA

Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )	
8-Pin MSOP (derate 4.1mW/°C above +70°C) .	330mW
Operating Temperature Ranges	40°C to +85°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Electrical and thermal stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to any absolute maximum rating conditions for extended periods may affect device reliability and lifetime.

## PACKAGE/ORDERING INFORMATION



Lead-free Program: Silicon Labs supplies only lead-free packaging.

Consult Silicon Labs for products specified with wider operating temperature ranges.



## **ELECTRICAL CHARACTERISTICS – 5V OPERATION**

 $V_{+} = 5V$ ,  $V_{-} = GND = 0V$ ;  $T_{A} = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted. Typical values are at  $T_{A} = +25^{\circ}C$ . See Note 1.

PARAMETER	CONDITIONS			MIN	TYP	MAX	UNITS		
POWER REQUIREMENTS									
Supply Voltage Range					2.5		11	V	
Supply Current	IN+ = IN- + 100mV		$HYST = REF \frac{T_A = +25^{\circ}C}{-40^{\circ}C \text{ to } +85^{\circ}C}$			2.6	4	μA	
11.2							5.2		
COMPARATOR			•				-		
Input Offset Voltage	$V_{CM} = 2.5V$		$T_A = +25^{\circ}C$				±3.5	mV	
input oneot voltage			-40°C to +85°C				±10		
Input Leakage Current (IN-, IN+)	IN+ = IN- = 2.5V		$T_A = +25^{\circ}C$			±0.01	±2	nA	
			-40°C to +85°C			±0.01	±5	nA	
Input Leakage Current (HYST)			$T_A = +25^{\circ}C$			±0.02		nA	
			-40°C to +85°C			±0.02		nA	
Input Common-Mode Voltage Range					V-		V+ – 1.3V	V	
Common-Mode Rejection Ratio	1	V- to (V+ - 1.3V)				0.1	1	mV/V	
Power-Supply Rejection Ratio	V+ = 2.5V to 11V				0.1	1	mV/V		
Output Voltage Noise	100Hz to 100kHz				20		$\mu V_{RMS}$		
Hysteresis Input Voltage Range					REF- 0.05V		REF	V	
Response Time	$T_{A} = +25^{\circ}C$ , 100pF load			/e = 10 mV		17		μs	
(High-to-Low Transition)		louu	0.0.0	/e = 100 mV		7		μ٥	
Response Time	T <sub>A</sub> = +25°C, 100pF Load			/e = 10 mV		17		μs	
(Low-to-High Transition)			Overdrive = 100 mV			7			
Output High Voltage				$I_{OUT} = 17mA$	V+-0.4			V	
Output Low Voltage	-40°C to +85°C; I <sub>OUT</sub> = 1.8mA						GND + 0.4	V	
	Dual Supply -40°C to +85°C; I <sub>OUT</sub> = 1.8mA		I <sub>OUT</sub> = 1.8mA			V-+0.4	V		
REFERENCE							-		
Reference Voltage			$T_{A} = +25$		1.173	1.182	1.191	V	
			-40°C to		1.164		1.199		
Reference Line Regulation	2.5V ≤ (V+ - V-) ≤ 11V		$T_A = +25^{\circ}C$			0.25		mV/V	
Source Current	ΔVREF = 1%		$T_{A} = +25$		20	25		μA	
			-40°C to		6				
Sink Current	ΔVREF = 1%		$T_{A} = +25$		10	15		μA	
		-4		+85°C	4				
Output Voltage Noise	100Hz to 100kHz				100		$\mu V_{RMS}$		



## **ELECTRICAL CHARACTERISTICS – 3V OPERATION**

 $V_{+} = 3V$ ,  $V_{-} = GND = 0V$ ;  $T_{A} = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted. Typical values are at  $T_{A} = +25^{\circ}C$ . See Note 1.

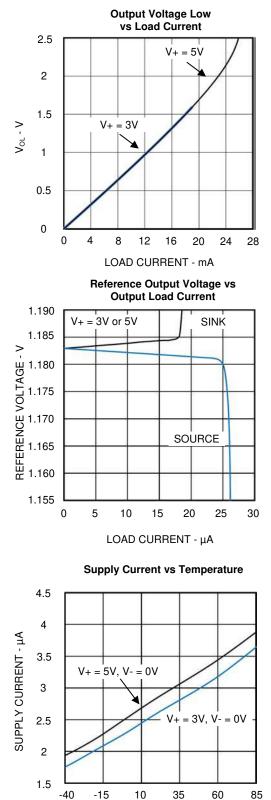
PARAMETER	CONDITIONS			MIN	TYP	MAX	UNITS	
POWER REQUIREMENTS	•							
Supply Current	$IN_{+} = IN_{-} + 100 mV$	HYST = REI	– T <sub>A</sub> = +25°C		2	3.8	μA	
Supply Current	IIN + = IIN - + IUUIIIV	HISI = REI	-40°C to +85°C			5.3		
COMPARATOR								
Input Offset Voltage	$V_{CM} = 1.5V$	$T_A = +$	$T_A = +25^{\circ}C$			±3.5	mV	
input Onset Voltage	$\mathbf{v}_{\rm CM} = 1.5 \mathbf{v}$	-40°C	-40°C to +85°C			±10		
Input Leakage Current (IN-, IN+)	IN+ = IN- = 1.5V	$T_A = +$	25°C		±0.01	±2	nA	
Input Leakage Current (IN-, IN+)	$110 + = 10^{-} = 1.5 v$	-40°C	-40°C to +85°C		±0.01	±5	nA	
Input Leakage Current (at HYST Pin)		$T_A = +$	$T_A = +25^{\circ}C$		±0.02		nA	
Input Leakage Current (at 11131 Fill)		-40°C	to +85°C		±0.02		nA	
Input Common-Mode Voltage Range				V-		V+-1.3V	V	
Common-Mode Rejection Ratio	V- to (V+ - 1.3V)				0.1	1	mV/V	
Power-Supply Rejection Ratio	V+ = 2.5V to 11V				0.1	1	mV/V	
Output Voltage Noise	100Hz to 100kHz				20		$\mu V_{RMS}$	
Hysteresis Input Voltage Range				REF- 0.05V		REF	V	
Response Time	T <sub>A</sub> = +25°C, 100pF I	Overd	rive = 10 mV		17			
(High-to-Low Transition)	$I_A = +25 \text{ C}, 100 \text{ pr}$	Overdrive = 100 mV			7		μs	
Response Time	T <sub>A</sub> = +25°C, 100pF I	Overd	rive = 10 mV		17		110	
(Low-to-High Transition)	$I_A = +25 \text{ C}, 100 \text{ pr}$	Overd	rive = 100 mV		7		μs	
Output High Voltage		-40°C to +85°C		V+-0.4			V	
Output Low Voltage		-40°C to +85°C	C; I <sub>OUT</sub> = 1.8mA			GND + 0.4	V	
Oulput Low Voltage	Dual Supply	-40°C to +85°C	C; I <sub>OUT</sub> = 1.8mA			V- + 0.4	V	
REFERENCE								
Reference Voltage		$T_A = +$	25°C	1.173	1.182	1.191	V	
Reference voltage		-40°C	to +85°C	1.164		1.199		
Reference Line Regulation	$2.5V \le (V_{+} - V_{-}) \le 5V_{-}$	V T <sub>A</sub> = +	25°C		0.25		mV/V	
Source Current	ΔVREF = 1%	$T_A = +$	25°C	20	25		μA	
	$\Delta V \Pi \Box I = 1\%$	-40°C	to +85°C	6				
Sink Current	ΔVREF = 1%	T <sub>A</sub> = +	25°C	10	15		μA	
Sink Current		-40°C	to +85°C	4				
Output Voltage Noise	100Hz to 100kHz				100		$\mu V_{RMS}$	

**Note 1:** All specifications are 100% tested at  $T_A = +25$ °C. Specification limits over temperature ( $T_A = T_{MIN}$  to  $T_{MAX}$ ) are guaranteed by device characterization, not production tested.

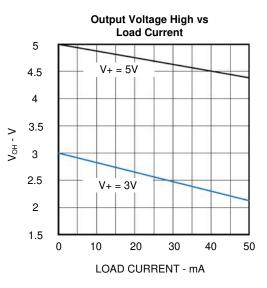


## **TYPICAL PERFORMANCE CHARACTERISTICS**

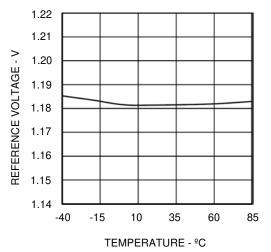
 $V_{*}$  = 5V;  $V_{\cdot}$  = GND;  $T_{A}$  = +25°C, unless otherwise noted.



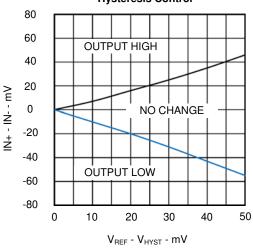
TEMPERATURE - ºC



**Reference Voltage vs Temperature** 





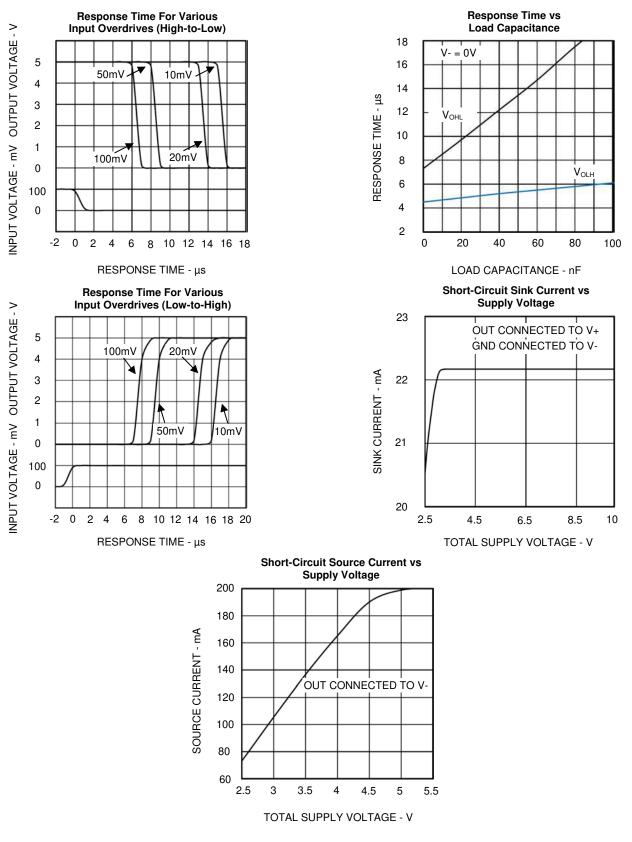






## **TYPICAL PERFORMANCE CHARACTERISTICS**

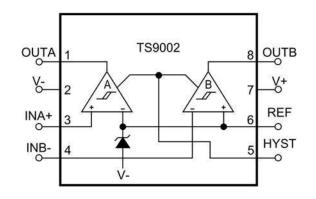
 $V_{\scriptscriptstyle +}=5V;\,V_{\scriptscriptstyle -}=GND;\,T_A=+25^{\circ}C,$  unless otherwise noted.





TS9002 MSOP-8	NAME	FUNCTION			
1	OUTA	Comparator A Output. Sinks and sources current. Swings from V+ to V			
2	V-	Negative Supply Voltage. Connect to ground for single-supply operation.			
3	INA+	Comparator A Noninverting Input			
4	INB-	Comparator B Inverting Input			
5	HYST	Hysteresis Input. Connect to REF if not used. Input voltage range is from VREF to (VREF - 50mV).			
6	REF	1.182V Reference Output with respect to V			
7	V+	Positive Supply Voltage			
8	OUTB	Comparator B Output. Sinks and sources current. Swings from V+ to V			

## **BLOCK DIAGRAM**



## THEORY OF OPERATION

The TS9002 dual, low-voltage, micropower analog comparator provides excellent flexibility and performance while sourcing continuously up to 40mA of current. The TS9002 draws less than  $5.5\mu$ A (total) over temperature for both comparators, including the reference. It also exhibits an input offset voltage of  $\pm 3.5$ mV, and has an on-board  $\pm 1.182$ V  $\pm 0.75\%$  voltage reference. To minimize glitches that can occur with parasitic feedback or a less than optimal board layout, the design of the TS9002 output stage is optimized to eliminate crowbar glitches as the output switches. To minimize current consumption while providing flexibility, TS9002 has an on-board HYST pin in order to add additional hysteresis.

### **Power-Supply and Input Signal Ranges**

The TS9002 can operate from a single supply voltage range of +2.5V to +11V, provides a wide common mode input voltage range of V- to V+-1.3V, and accepts input signals ranging from V- to V+ - 1V. The inputs can accept an input as much as 300mV above and below the power supply rails without damage to the part. The TS9002 is TTL compatible with a single +5V supply.

#### **Comparator Output**

The output design of the TS9002 can source and sink more than 40mA and 5mA, respectively, while simultaneously maintaining a quiescent current less

# **TS9002**



than  $3\mu$ A. If the power dissipation of the package is maintained within the max limit, the output can source pulses of 100mA of current with V+ set to +5V. In an effort to minimize external components needed to address power supply feedback, the TS9002 output does not produce crowbar switching current as the output switches. At a power supply voltage of 3V, the propagation delay of the TS9002 is 6µs when the output switches from high-to-low and low-to-high.

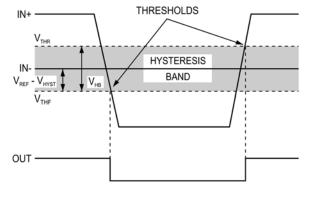
#### Voltage Reference

The TS9002 has an on-board +1.182V voltage reference with an accuracy of  $\pm 0.75\%$ . The REF pin is able to source and sink 20µA and 10µA of current,

## **APPLICATIONS INFORMATION**

#### Hysteresis

As a result of circuit noise or unintended parasitic feedback, many analog comparators often break into oscillation within their linear region of operation especially when the applied differential input voltage approaches 0V (zero volt). Externally-introduced hysteresis is a well-established technique to stabilizing analog comparator behavior and requires external components. As shown in Figure 1, adding comparator hysteresis creates two trip points: V<sub>THR</sub> (for the rising input voltage) and  $V_{\text{THF}}$  (for the falling input voltage). The hysteresis band ( $V_{HB}$ ) is defined as the voltage difference between the two trip points. When a comparator's input voltages are equal, hysteresis effectively forces one comparator input to move quickly past the other input, moving the input out of the region where oscillation occurs. Figure 1 illustrates the case in which an IN- input is a fixed





respectively. The REF pin is referenced to V- and it should not be bypassed.

#### **Noise Considerations**

Noise can play a role in the overall performance of the TS9002. Despite having a large gain, if the input voltage is near or equal to the input offset voltage, the output will randomly switch HIGH and LOW. As a result, the TS9002 produces a peak-to-peak noise of about 0.3mV<sub>PP</sub> while the reference voltage produces a peak-to-peak noise of about 1mv<sub>PP</sub>. Furthermore, it is important to design a layout that minimizes capacitive coupling from a given output to the reference pin as crosstalk can add noise and as a result, degrade performance.

voltage and an IN+ is varied. If the input signals were reversed, the figure would be the same with an inverted output. Hysteresis can be generated with two external resistors using positive feedback as shown in Figure 2. Resistor R1 is connected between REF and HYST and R2 is connected between HYST and V-. This will increase the trip

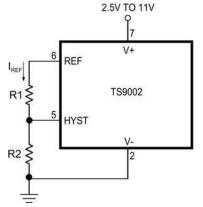


Figure 2. Programming the HYST Pin

point for the rising input voltage,  $V_{THR}$ , and decrease the trip point for the falling input voltage,  $V_{THF}$ , by the same amount. If no hysteresis is required, connect HYST to REF. The hysteresis band,  $V_{HB}$ , is voltage across the REF and HYST pin multiplied by a factor of 2. The HYST pin can accept a voltage between REF and REF-50mV, where a voltage of REF-50mV generates the maximum voltage across R1 and thus, the maximum hysteresis and hysteresis band of 50mV and 100mV, respectively. To design the circuit for a desired hysteresis band, consider the equations below to acquire the values for resistors R1 and R2:



$$R1 = \frac{V_{HB}}{(2 \times I_{REF})}$$
$$R2 = \frac{1.182 - \frac{V_{HB}}{2}}{I_{REF}}$$

where  $I_{REF}$  is the primary source of current out of the reference pin and should be maintained within the maximum current the reference can source. It is safe to maintain the current within 20µA. It is also important to ensure that the current from reference is much larger than the HYST pin input current. Given R2 = 2.4M $\Omega$ , the current sourced by the reference is 0.5µA. This allows the hysteresis band and R1 to be approximated as follows:

 $R1(k\Omega) = V_{HB}(mv)$ 

Note the hysteresis is the same for both comparators.

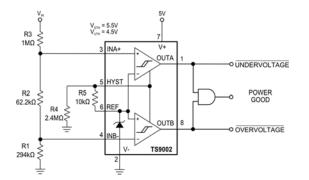
### **Board Layout and Bypassing**

While power-supply bypass capacitors are not typically required, it is good engineering practice to use  $0.1\mu$ F bypass capacitors close to the device's power supply pins when the power supply impedance is high, the power supply leads are long, or there is excessive noise on the power supply traces. To reduce stray capacitance, it is also good engineering practice to make signal trace lengths as short as possible. Also recommended are a ground plane and surface mount resistors and capacitors.

#### Window Detector

The schematic shown in Figure 3 is for a 4.5V undervoltage threshold detector and a 5.5V overvoltage threshold detector using the TS9002. Resistor components R1, R2, and R3 can be selected based on the threshold voltage desired while resistors R4 and R5 can be selected based on the hysteresis desired. Adding hysteresis to the circuit will minimize chattering on the output when the input voltage is close to the trip point. OUTA and OUTB generate the active low undervoltage indication and active-low overvoltage indication, respectively. If both OUTA and OUTB signals are ANDed together, the resulting output of the AND gate is an active-high, power-good signal. To design the circuit, the following procedure needs to be followed:

 As described below, determine the desired hysteresis and select resistors R4 and R5 accordingly. This circuit has ±5mV of hysteresis at the input where the input voltage V<sub>IN</sub> will appear larger due to the input resistor divider.



#### Figure 3. Window Detector

- 2. Choosing R1. As the leakage current at the INB- pin is less than 1nA, the current through R1 should be at least 100nA to minimize offset voltage errors caused by the input leakage current. Values within 100k $\Omega$  and 1M $\Omega$  are recommended. In this example, a 294k $\Omega$ , 1% standard value resistor is selected for R1.
- 3. Calculating R2 + R3. As the input voltage V<sub>IN</sub> rises, the overvoltage threshold should be 5.5V. Choose R2 + R3 as follows:

R1 + R3 = R1 x 
$$\left(\frac{V_{OTH}}{V_{REF}+V_{HYS}}-1\right)$$
  
= 294k $\Omega$  x  $\left(\frac{5.5V}{1.182V+5mV}-1\right)$   
= 1.068M $\Omega$ 

 Calculating R2. As the input voltage V<sub>IN</sub> falls, the undervoltage threshold should be 4.5V. Choose R2 as follows:

R2 = (R1 + R2+ R3) x 
$$\frac{(V_{REF}-V_{HYS})}{V_{UTH}}$$
- 294k

$$= (294k\Omega + 1.068M\Omega) \times \frac{(1.182V-5mV)}{4.5} - 294k$$
$$= 62.2k\Omega$$

# TS9002



In this example, a 61.9k $\Omega,$  1% standard value resistor is selected for R2.

5. Calculating R3.

R3 = (R2 + R3) - R2= 1.068M $\Omega$  - 61.9k $\Omega$ 

= 1.006MΩ

In this example, a 1M $\Omega$ , 1% standard value resistor is selected for R3.

6. Using the equations below, verify all resistor values selected:

$$V_{OTH} = (V_{REF} + V_{HYS}) \times \frac{(R1 + R2 + R3)}{R1}$$

= 5.474V

$$V_{OTH} = (V_{REF} - V_{HYS}) \times \frac{(R1 + R2 + R3)}{(R1 + R2)}$$

= 4.484V

Where the hysteresis voltage is given by:

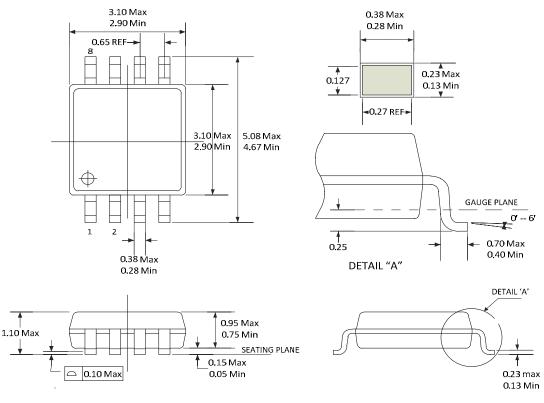
 $V_{HYS} = V_{REF} \times \frac{R5}{R4}$ 



PACKAGE OUTLINE DRAWING

8-Pin MSOP Package Outline Drawing

(N.B., Drawings are not to scale)



NOTE:

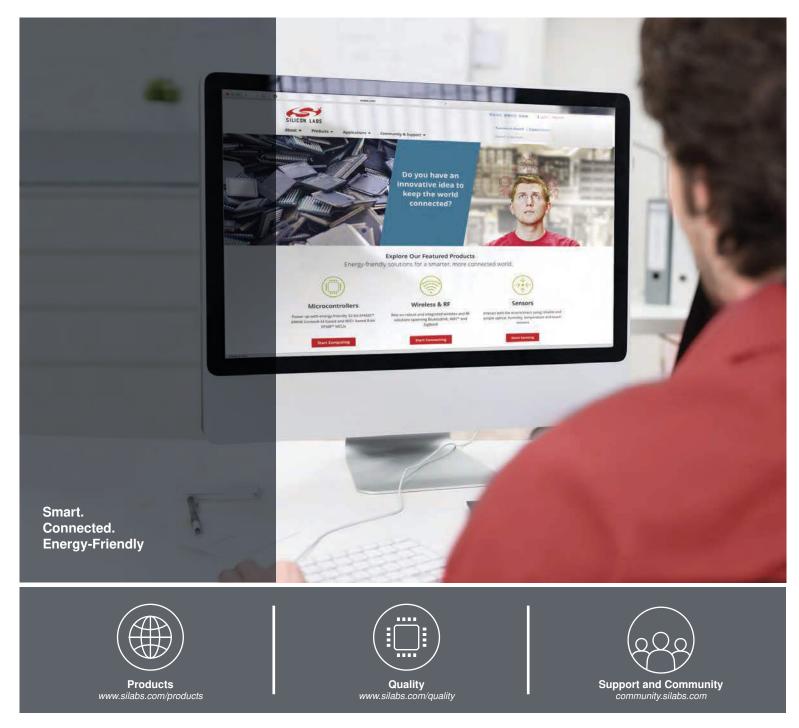
- 1. PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- 2. PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTUSIONS.
- 3. CONTROLLING DIMENSION IN MILIMETERS.
- 4. THIS PART IS COMPLIANT WITH JEDEC MO-187 VARIATIONS AA
- 5. LEAD SPAN/STAND OFF HEIGHT/COPLANARITY ARE CONSIDERED AS SPECIAL CHARACTERISTIC.

#### **Patent Notice**

Silicon Labs invests in research and development to help our customers differentiate in the market with innovative low-power, small size, analog-intensive mixed-signal solutions. Silicon Labs' extensive patent portfolio is a testament to our unique approach and world-class engineering team.

The information in this document is believed to be accurate in all respects at the time of publication but is subject to change without notice. Silicon Laboratories assumes no responsibility for errors and omissions, and disclaims responsibility for any consequences resulting from the use of information included herein. Additionally, Silicon Laboratories assumes no responsibility for the functioning of undescribed features or parameters. Silicon Laboratories reserves the right to make changes without further notice. Silicon Laboratories makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Silicon Laboratories assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. Silicon Laboratories products are not designed, intended, or authorized for use in applications intended to support or sustain life, or for any other application in which the failure of the Silicon Laboratories product could create a situation where personal injury or death may occur. Should Buyer purchase or use Silicon Laboratories products for any such unintended or unauthorized application, Buyer shall indemnify and hold Silicon Laboratories harmless against all claims and damages.

Silicon Laboratories and Silicon Labs are trademarks of Silicon Laboratories Inc. Other products or brandnames mentioned herein are trademarks or registered trademarks of their respective holders.



#### Disclaimer

Silicon Laboratories intends to provide customers with the latest, accurate, and in-depth documentation of all peripherals and modules available for system and software implementers using or intending to use the Silicon Laboratories products. Characterization data, available modules and peripherals, memory sizes and memory addresses refer to each specific device, and "Typical" parameters provided can and do vary in different applications. Application examples described herein are for illustrative purposes only. Silicon Laboratories reserves the right to make changes without further notice and limitation to product information, specifications, and descriptions herein, and does not give warranties as to the accuracy or completeness of the included information. Silicon Laboratories shall have no liability for the consequences of use of the information supplied herein. This document does not imply or express copyright licenses granted hereunder to design or fabricate any integrated circuits. The products must not be used within any Life Support System without the specific to result in significant personal injury or death. Silicon Laboratories products are generally not intended to support or sustain life and/or health, which, if it fails, can be reasonably expected to result in significant personal injury or death. Silicon Laboratories products not be used in weapons, or missiles capable of delivering such weapons.

#### **Trademark Information**

Silicon Laboratories Inc., Silicon Laboratories, Silicon Labs, SiLabs and the Silicon Labs logo, CMEMS®, EFM, EFM32, EFR, Energy Micro, Energy Micro logo and combinations thereof, "the world's most energy friendly microcontrollers", Ember®, EZLink®, EZMac®, EZRadio®, EZRadioPRO®, DSPLL®, ISOmodem ®, Precision32®, ProSLIC®, SiPHY®, USBXpress® and others are trademarks or registered trademarks of Silicon Laboratories Inc. ARM, CORTEX, Cortex-M3 and THUMB are trademarks or registered trademarks of ARM Holdings. Keil is a registered trademark of ARM Limited. All other products or brand names mentioned herein are trademarks of their respective holders.



Silicon Laboratories Inc. 400 West Cesar Chavez Austin, TX 78701 USA

## http://www.silabs.com